

**EVLYS LTD. - POWER SEMICONDUCTORS DEVICES -**  
**Wholesale and Retail.**

**Phase Control Disc Thyristor Type DT99-3600-36**

High power cycling capability / Low on-state and switching losses  
 Designed for traction and industrial applications

Mean on-state current	I <sub>TAV</sub>	3600 A		
Repetitive peak off-state voltage	V <sub>DRM</sub>	3000...3600 V		
Repetitive peak reverse voltage	V <sub>RRM</sub>			
Turn-off time	t <sub>q</sub>	630 μs		
V <sub>DRM</sub> , V <sub>RRM</sub> , V	3000	3200	3400	3600
Voltage code	30	32	34	36
T <sub>j</sub> , °C		-60...+125		

**MAXIMUM ALLOWABLE RATINGS**

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
I <sub>TAV</sub>	Maximum allowable mean on-state current	A	3600 4540	T <sub>c</sub> = 86 °C, Double side cooled T <sub>c</sub> = 70 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TRMS</sub>	RMS on-state current	A	5652	T <sub>c</sub> = 86 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TSM</sub>	Surge on-state current	kA	72.0 83.0	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt≥1 A/μs
			76.0 87.0	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt≥1 A/μs
I <sup>2</sup> t	Safety factor	A <sup>2</sup> s·10 <sup>3</sup>	25900 34400	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt≥1 A/μs
			23900 31400	T <sub>j</sub> =T <sub>j max</sub> T <sub>j</sub> =25 °C	180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 μs; di <sub>G</sub> /dt≥1 A/μs
<b>BLOCKING</b>					
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse voltages	V	3000...3600	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ; 180° half-sine wave; 50 Hz; Gate open	
V <sub>DSM</sub> , V <sub>RSM</sub>	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3100...3700	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j max</sub> ; 180° half-sine wave; single pulse; Gate open	
V <sub>D</sub> , V <sub>R</sub>	Direct off-state and Direct reverse voltages	V	0.6·V <sub>DRM</sub> 0.6·V <sub>RRM</sub>	T <sub>j</sub> =T <sub>j max</sub> ; Gate open	

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TRIGGERING				
$I_{FGM}$	Peak forward gate current	A	12	
$V_{RGM}$	Peak reverse gate voltage	V	5	$T_j = T_{j \max}$
$P_G$	Gate power dissipation	W	5	$T_j = T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{\text{crit}}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ $\mu$ s	1000	$T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 7200$ A; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
THERMAL				
$T_{stg}$	Storage temperature	°C	-60...+50	
$T_j$	Operating junction temperature	°C	-60...+125	
MECHANICAL				
F	Mounting force	kN	70.0...90.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

### CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
<b>ON-STATE</b>					
$V_{TM}$	Peak on-state voltage, max	V	1.70	$T_j = 25$ °C; $I_{TM} = 6300$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	0.90	$T_j = T_{j \max};$	
$r_T$	On-state slope resistance, max	$\text{m}\Omega$	0.110	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
$I_L$	Latching current, max	mA	1500	$T_j = 25$ °C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s	
$I_H$	Holding current, max	mA	300	$T_j = 25$ °C; $V_D = 12$ V; Gate open	
<b>BLOCKING</b>					
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j \max};$ $V_D = V_{DRM}; V_R = V_{RRM}$	
$(dv_D/dt)_{\text{crit}}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	500, 1000, 1600	$T_j = T_{j \max};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open	
<b>TRIGGERING</b>					
$V_{GT}$	Gate trigger direct voltage, max	V	5.00 3.00 2.00	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	500 300 200	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.35	$T_j = T_{j \max};$ $V_D = 0.67 \cdot V_{DRM};$	
$I_{GD}$	Gate non-trigger direct current, min	mA	15.00	Direct gate current	
<b>SWITCHING</b>					
$t_{gd}$	Delay time, max	$\mu$ s	3.00	$T_j = 25$ °C; $V_D = 1500$ V; $I_{TM} = I_{TAV};$ Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	630	$dv_D/dt = 50 \text{ V}/\mu\text{s}; T_j = T_{j \max}; I_{TM} = 1000 \text{ A};$ $di_R/dt = -10 \text{ A}/\mu\text{s}; V_R = 100 \text{ V};$ $V_D = 0.67 V_{DRM}$	
$Q_{rr}$	Recovered charge, max	$\mu$ C	7000	$T_j = T_{j \max}; I_{TM} = 1000 \text{ A};$	
$t_{rr}$	Reverse recovery time, max	$\mu$ s	68	$di_R/dt = -5 \text{ A}/\mu\text{s};$	
$I_{rr}$	Reverse recovery current, max	A	205	$V_R = 100 \text{ V}$	

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THERMAL					
$R_{thjc}$	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0057	Direct current	Double side cooled
$R_{thjc-A}$			0.0125		Anode side cooled
$R_{thjc-K}$			0.0103		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0010	Direct current	
MECHANICAL					
m	Weight, max	g	2700		
$D_s$	Surface creepage distance	mm (inch)	62.09 (2.444)		
$D_a$	Air strike distance	mm (inch)	23.40 (0.921)		

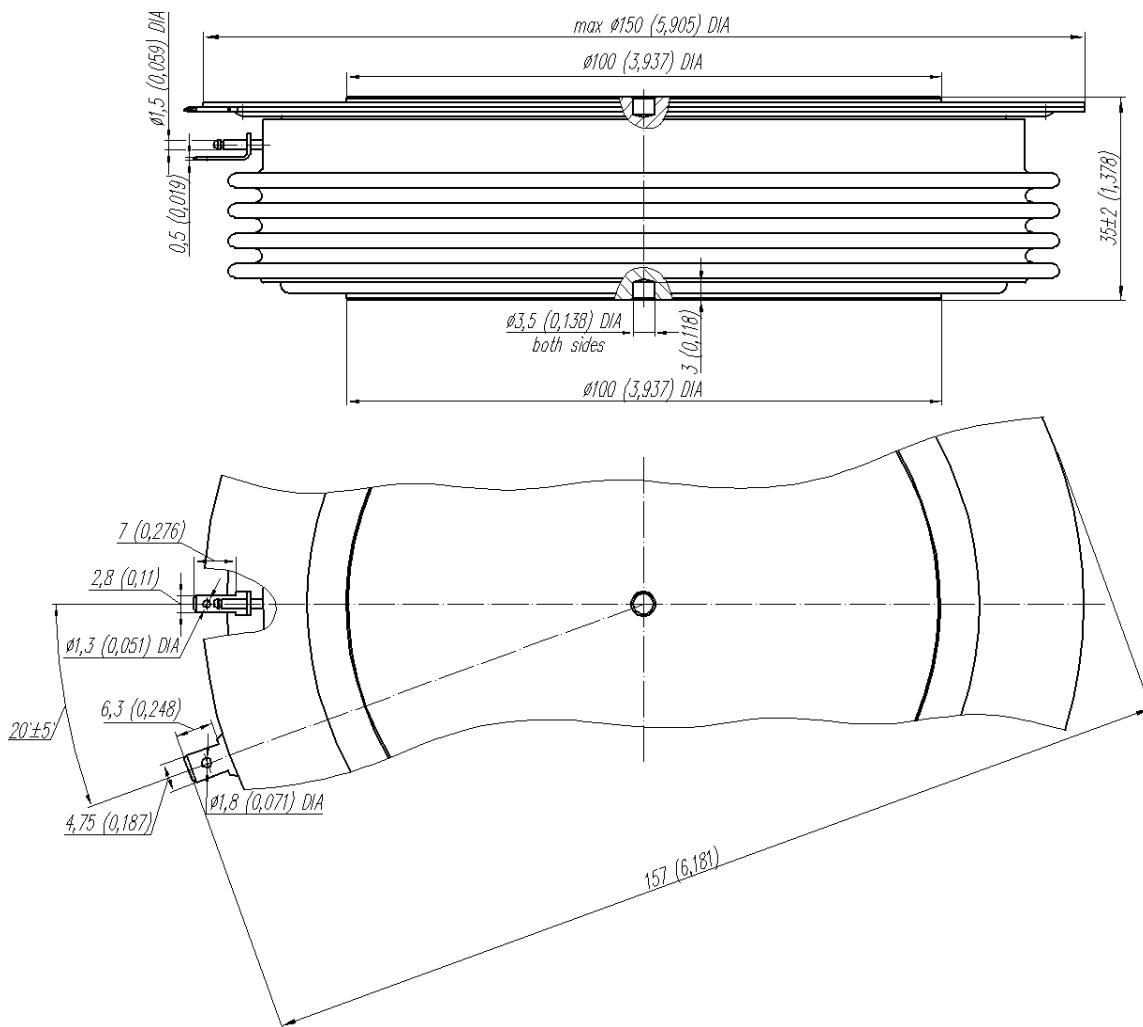
PART NUMBERING GUIDE						NOTES		
DT	99	3600	36	7	3	1	2	3
1	2	3	4	5	6	Symbol of Group $(dv_b/dt)_{crit}, \text{V}/\mu\text{s}$	6	7
1. DT - Phase Control Disc Thyristor	2. Element Diameter	3. Mean on-state current, A	4. Voltage code	5. Critical rate of rise of on-state current non-repetitive, V/ $\mu\text{s}$	6. Turn-off time ( $dv_D/dt=50 \text{ V}/\mu\text{s}$ )	500	1000	1600
						Symbol of Group $t_{tr}, \mu\text{s}$	0	630

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### **OVERALL DIMENSIONS**

**Package type: T.G6**



All dimensions in millimeters (inches)